



PCB Number: TIDA-01613
PCB Rev: E1

PCB LOGO
Texas Instruments

PCB LOGO
Pb-Free Symbol

PCB LOGO
FCC disclaimer

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: ChangeMe!	Designed for: Public Release	Mod. Date: 11/24/2017	 TEXAS INSTRUMENTS http://www.ti.com © Texas Instruments 2016
TID #: N/A	Project Title: TPS65150_EMI		
Number: TIDA-01613	Rev: E1	Sheet: 2 of 2	
SVN Rev: Version control disabled	Assembly Variant: 001		
Drawn By: Fred Illguth	File: TIDA-01613_TPS65150_EMI_Hardware.SchDoc Size: B		
Engineer:	Contact: http://www.ti.com/support		

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